



Notice of References Cited

Application/Control No. 09/966,445	Applicant(s)/I Reexamination	on
Examiner	Art Unit	
Thomas J. Magee	2811	Page 1 of 1

U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
-	Α	US-6,420,200 B1	07-2002	Shunpei Yamazaki et al.	438/30
	В	US-6,369,507 B1	04-2002	Michio Arai	313/506
	С	US-5,986,632	11-1999	Ichiro Takayama et al.	345/99
	D	US-			
	E	US-			
	F	US-			
	G	US-			
	Н	US-			
	١	US-			
	J	US-			
	К	US-			
	L	US-			
	м	US-			

FOREIGN PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
	N					
	0					
	Р					
	Q					
	R					
	s					
	Т					

NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	Syd R. Wilson, Clarence J. Tracy, and John L. Freeman, Jr., "Handbook of Multilevel Metallization for Integrated Circuits," Noyes Publ., Westwood, New Jersey (1993), pp.357, 386, 389.
	٧	
	W	
	х	

*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).) Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.